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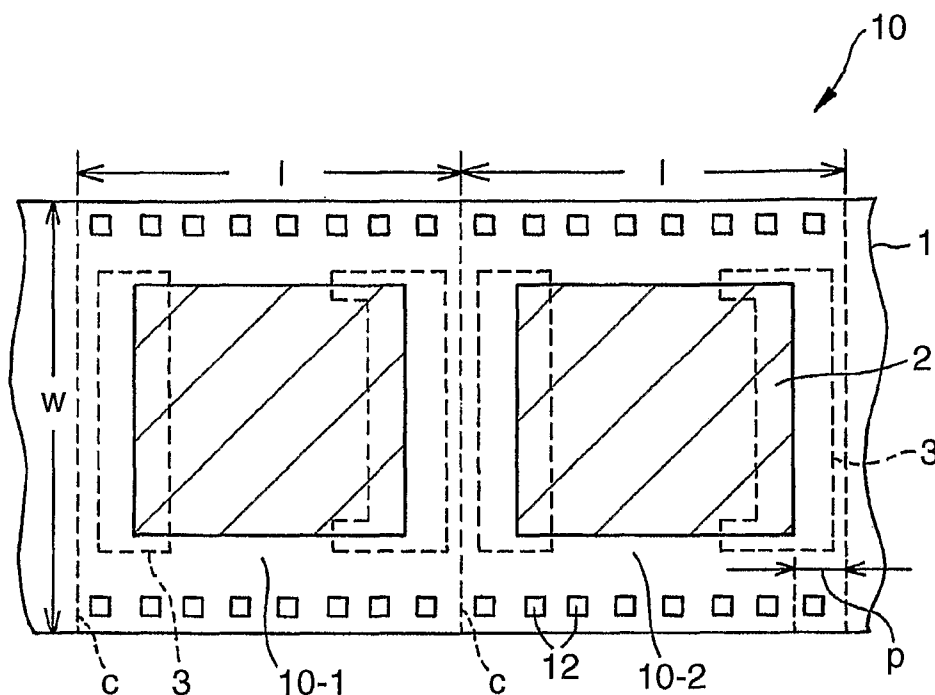
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(54) Title: PROCESS OF PRODUCING PRINTED WIRING BOARD



(57) Abstract: Provided is a process for providing a printed wiring board equipped with a reinforcing sheet that has simple processing steps, a small number of steps and therefore can be carried out easily, simply and in a short period of time, while also allowing en bloc, large-volume production instead of batch production.

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